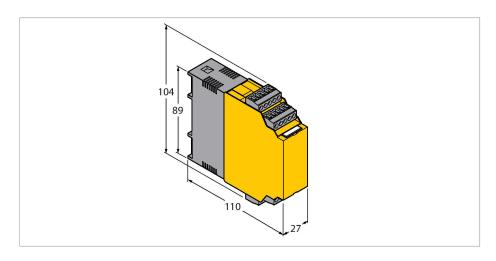


FM-IM-2UPLI63FX

Processor Unit – For the Connection of FP Product Series Non-Ex Flow Sensors

IO-Link Device with Current and Transistor Switching Outputs



Technical data

Туре	FM-IM-2UPLI63FX
ID	100000819
Electrical data	
Operating voltage U _B	2030 VDC
Power consumption	< 4.5 W
No-load current I _o	≤ 63 mA
Teach modes	Min/max adjustment. Teach modes incl. DeltaFlow monitoring (teach modes are automatically released with the change of flow speed).
Flow speed	[%] after min/max adjustment (permanent)
Medium temperature	[°C] with the SET button temporarily pressed
Repeatability flow rate	typical ± 1 % (of full scale)
Repeatability media temperature	typical ± 1 K
Measuring accuracy media temperature	typical ± 7 K
Switchpoint hysteresis media temperature	2 K
Input function	Connection of flow sensors (non-Ex sensors of the FP100/FP150 product series only!)
Sensor voltage	≤ 15 VDC
Sensor current	≤ 35 mA
Sensor current limitation	approx. 110 mA
Measuring frequency	5 Hz (every 200 ms with software filter)

Features

- ■Analog output for flow
- Transistor switching outputs for temperature and faults
- ■Teaching upper and lower flow limit
- ■LED band for indication of flow rate and media temperature
- Monitoring of operating and display range
- Detection of wire-break and short-circuit on the sensor side
- Standard IO or IO-Link operating mode
- Parametrized via pushbutton or software-supported via IO-Link

Functional principle

With the external processing unit type FM-IM-...FX, all non-Ex flow sensors of the FP100 series (immersion sensors) can be operated.

The flow module features four status LEDs as well as a 10-segment LED band for local monitoring. Software-based diagnostic options are also available to the user, such as wire-break and short-circuit on the sensor side. Furthermore, monitoring of flow rates and media temperatures within a predefined operating and display range.

The upper and lower limit are determined in relation to the analog output signal and taught in using the implemented teach mode. Working on the calorimetric principle, the connectible sensors not only detect the flow rate but also the media temperature.

The flow module can be operated either in IO-Link (IOL) or in standard IO (SIO) mode via the integrated IO-Link interface. In SIO mode, the switching outputs are operated in the standard way. In IOL mode the current process signal is transmitted cyclically as a 10 bit-serial value.

Parametrization is initiated either via pushbutton or software-supported via IO-Link interface. The actual parametrization is then implemented via the tool-based DTM or IODD within the FDT frame PACTware $^{\rm TM}$ or acyclically near the control via On-Request Data Objects (ORDO).



Technical data

Flow monitoring Analog output Temperature monitoring transistor output Error monitoring transistor output Current range 420 mA / 204 mA parametrizable Load < 600 Ω Characteristic Output of probe signal, no linearization Error recognition NAMUR error limits Switching characteristic PNP Switching state active high / active low parametrizable (transistor output error monitoring only active low) Switching state 2030 VDC Switching current 100 mA Electrical connections 5-pole removable reverse polarity protected terminal blocks Connection mode screw connection Terminal cross-section ≥ 1.5≤ 2.5 mm² IO-Link V 1.1 ITransmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Clamp 12 and via front panel jack COM (PC) Communication modes Clamp 12 and via front panel jack COM (PC) Communication modes Clamp 12 and via front panel jack COM (PC) C	Output functions	
Error monitoring transistor output Current range 420 mA / 204 mA parametrizable Load < 600 Ω	Flow monitoring	Analog output
Current range 420 mA / 204 mA parametrizable Load < 600 Ω	Temperature monitoring	transistor output
Load < 600 Ω	Error monitoring	transistor output
Characteristic Output of probe signal, no linearization Error recognition NAMUR error limits Switching characteristic PNP Switching state active high / active low parametrizable (transistor output error monitoring only active low) Switching voltage 2030 VDC Switching current 100 mA Electrical connections 5-pole removable reverse polarity protected terminal blocks Connection mode screw connection Terminal cross-section ≥ 1.5≤ 2.5 mm² IO-Link IO-Link IO-Link IO-Link specification V 1.1 Transmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Acc. to NE21 Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Current range	420 mA / 204 mA parametrizable
Error recognition Switching characteristic Switching state Active high / active low parametrizable (transistor output error monitoring only active low) Switching voltage 2030 VDC Switching current 100 mA Electrical connections Electrical connections Screw connection Terminal cross-section 10-Link IO-Link IO-Link specification V1.1 Transmission rate 38.4 kBit/s (COM 2) Transmission physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Acc. to NE21 Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel	Load	< 600 Ω
Switching characteristic PNP Switching state active high / active low parametrizable (transistor output error monitoring only active low) Switching voltage 2030 VDC Switching current 100 mA Electrical connections 5-pole removable reverse polarity protected terminal blocks Connection mode screw connection Terminal cross-section ≥ 1.5≤ 2.5 mm² IO-Link IO-Link specification V1.1 Transmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Acc. to NE21 Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class	Characteristic	Output of probe signal, no linearization
Switching state active high / active low parametrizable (transistor output error monitoring only active low) Switching voltage 2030 VDC Switching current 100 mA Electrical connections 5-pole removable reverse polarity protected terminal blocks Connection mode 3-1.5\$\(\) 2.5 mm² IO-Link IO-Link IO-Link specification V 1.1 Transmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Acc. to NE21 Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel	Error recognition	NAMUR error limits
(transistor output error monitoring only active low) Switching voltage 2030 VDC Switching current 100 mA Electrical connections 5-pole removable reverse polarity protected terminal blocks Connection mode screw connection Terminal cross-section ≥ 1.5≤ 2.5 mm² IO-Link IO-Link IO-Link specification V 1.1 Transmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Acc. to NE21 Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Switching characteristic	PNP
Switching current Electrical connections 5-pole removable reverse polarity protected terminal blocks Connection mode Screw connection Terminal cross-section ≥ 1.5≤ 2.5 mm² IO-Link IO-Link specification V 1.1 Transmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel	Switching state	(transistor output error monitoring only
Electrical connections 5-pole removable reverse polarity protected terminal blocks Connection mode Screw connection 10-Link 10-Link specification Transmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel	Switching voltage	2030 VDC
ed terminal blocks Connection mode Terminal cross-section ≥ 1.5≤ 2.5 mm² IO-Link IO-Link specification Transmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel	Switching current	100 mA
Terminal cross-section ≥ 1.5≤ 2.5 mm² IO-Link IO-Link specification V 1.1 Transmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Acc. to NE21 Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Electrical connections	5-pole removable reverse polarity protected terminal blocks
IO-Link IO-Link specification V 1.1 Transmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Acc. to NE21 Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Connection mode	screw connection
IO-Link specification V 1.1 Transmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Acc. to NE21 Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class	Terminal cross-section	≥ 1.5≤ 2.5 mm²
Transmission rate 38.4 kBit/s (COM 2) Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class	IO-Link	
Transmission physics Transmission physics 3-wire physics (PHY 2) Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class	IO-Link specification	V 1.1
Communication channel Clamp 12 and via front panel jack COM (PC) Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Acc. to NE21 Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Transmission rate	38.4 kBit/s (COM 2)
Communication modes Tool based engineering via FDT / DTM, IODD. Acyclic communication via On-Request Data Objects Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class	Transmission physics	
Included in the SIDI GSDML Yes Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions By x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature Protection class IP20	Communication channel	
Tests/approvals Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class	Communication modes	IODD. Acyclic communication via On-Re-
Approvals CE, C-UL U.S. submitted Electromagnetic compatibility (EMC) Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Included in the SIDI GSDML	Yes
Electromagnetic compatibility (EMC) Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Tests/approvals	
Relative humidity EN 60068-2-38 Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Approvals	CE, C-UL U.S. submitted
Mechanical data Design Signal processor Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Electromagnetic compatibility (EMC)	Acc. to NE21
DesignSignal processorDimensions89 x 110 x 27 mmHousing materialPlastic, Polycarbonate/ABSAmbient temperature-25+70 °CMounting typeDIN rail mounting and mounting panelProtection classIP20	Relative humidity	EN 60068-2-38
Dimensions 89 x 110 x 27 mm Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Mechanical data	
Housing material Plastic, Polycarbonate/ABS Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Design	Signal processor
Ambient temperature -25+70 °C Mounting type DIN rail mounting and mounting panel Protection class IP20	Dimensions	89 x 110 x 27 mm
Mounting type DIN rail mounting and mounting panel Protection class IP20	Housing material	Plastic, Polycarbonate/ABS
Protection class IP20	Ambient temperature	-25+70 °C
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	Mounting type	DIN rail mounting and mounting panel
MTBF 117 Years	Protection class	IP20
	MTBF	117 Years



LED display

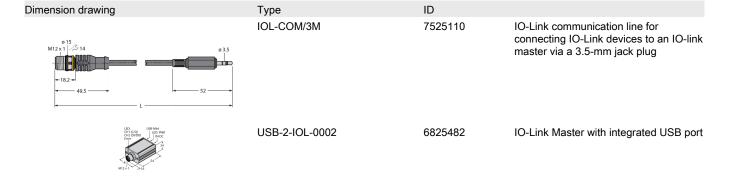
LED	Color	Status	Description
Pwr	green	on	Operating voltage applied
			Device ready for operation
		flashing	Operating voltage applied
			IO-Link communication active
			(inverted flash with T on 900 ms and T off 100 ms)
Flow	yellow	on	Active current output
		flashing	Teach mode / display of diagnostic data
			for specification see manual
Temp	yellow	off	Switching output media temperature [low]
		on	Switching output media temperature [high]
		flashing	Teach mode / display of diagnostic data
			for specification see manual
Fault	Red	Off	Switching output fault [high]
		On	Switching output flow [low]
			(for error pattern in combination with LEDs see manual)

For detailed description of the display patterns and flashing codes see instruction manual FM-IM/FMX-IM

IO-Link (Process Data Objects)

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	Flow Value 10 Bit (Bit 15 = MSB, Bit 6 = LSB)									not a	ssigr	ned	Out 3	Out 2	Out1	
				,					,			Ū		(Fault)	(Temp)	(Flow)

Accessories



Accessories

